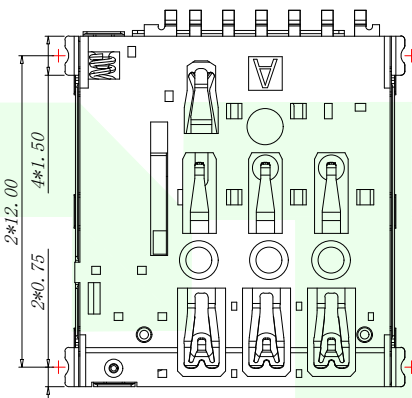
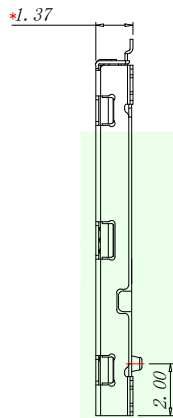
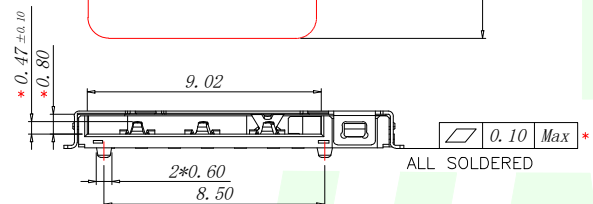
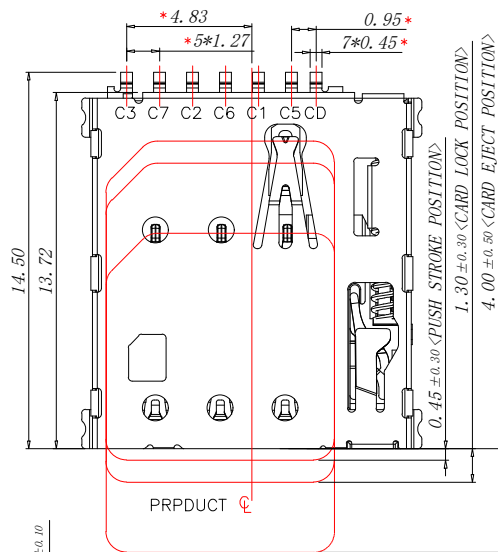
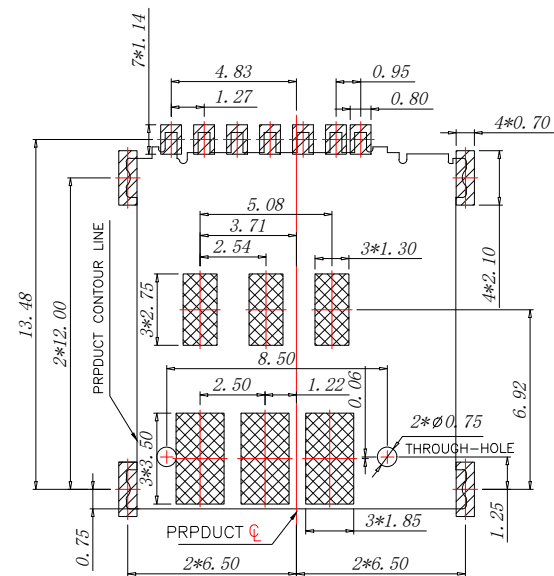


RoHS

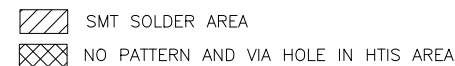


3D VIEW



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

RECOMMENDED MATAL MASK T=0.12mm



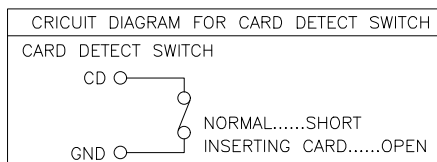
PART INSTRUCTIONS:

PART NUMBER	DESCRIPTION
SIM3061C-7P511-H137	WITH POST
SIM30610-7P511-H137	NO POST

NOTES:

- MATERIAL:
HOUSING: High Temperature Thermoplastic
Terminal: Copper Alloy
Shell: Stainless Steel
- PLATING:
Terminal: 50u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
Shell: 30u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA
- TECHNICAL SPECIALITY:
RATED VOLTAGE: 30V AC MAX.
CURRENT RATING: 0.5A MAX.
INSULATION RESISTANCE: 1000MΩ MIN
CONTACT RESISTANCE: 50mΩ MAX
WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES
OPERATING TEMPERATURE: -25°C~+85°C 80% R.H MAX
- DIMENSIONS WITH MARK" * "MUST BE MEASURE BY QC AND IPQC

PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O

GENERAL TOLERANCES
UNLESS SPECIFIED

X.X	±0.30	X.*	±5°
.XX	±0.20	X.X*	±1°
.XXX	±0.10	X.XX*	±0.5°

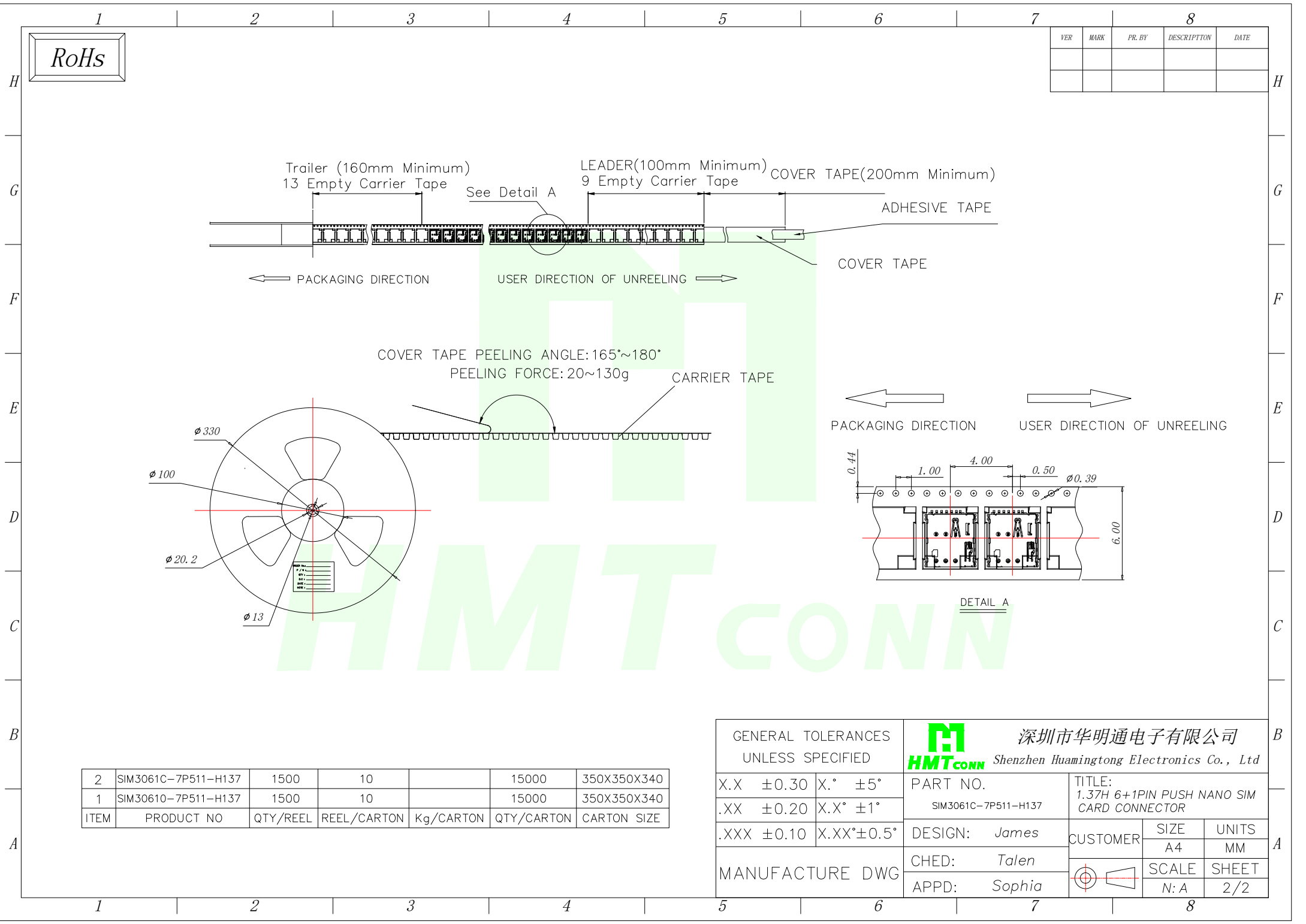
MANUFACTURE DWG

深圳市华明通电子有限公司
Shenzhen Huamingtong Electronics Co., Ltd

PART NO.	SIM3061C-7P511-H137
DESIGN:	James
CHED:	Talen
APPD:	Sophia

TITLE:
1.37H 6+1PIN PUSH NANO SIM
CARD CONNECTOR

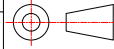
CUSTOMER	SIZE	UNITS
	A4	MM
SCALE	SHEET	
	N:A	1/2



RoHs

VER	MARK	PR. BY	DESCRIPTION	DATE

2	SIM3061C-7P511-H137	1500	10		15000	350X350X340
1	SIM30610-7P511-H137	1500	10		15000	350X350X340
ITEM	PRODUCT NO	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

GENERAL TOLERANCES UNLESS SPECIFIED		 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd	
X.X ±0.30	X.° ±5°	PART NO.	TITLE:
.XX ±0.20	X.X° ±1°	SIM3061C-7P511-H137	1.37H 6+1PIN PUSH NANO SIM CARD CONNECTOR
.XXX ±0.10	X.XX° ±0.5°	DESIGN: James	CUSTOMER
MANUFACTURE DWG		CHEDED: Talen	SIZE
		APPD: Sophia	A4
			UNITS
			MM
			SCALE
			SHEET
			N: A
			2/2